

NPN 5 GHz wideband transistor**BFR106****DESCRIPTION**

NPN silicon planar epitaxial transistor in a plastic SOT23 envelope. It is primarily intended for low noise, general RF applications.

PINNING

PIN	DESCRIPTION
Code: R7p	
1	base
2	emitter
3	collector

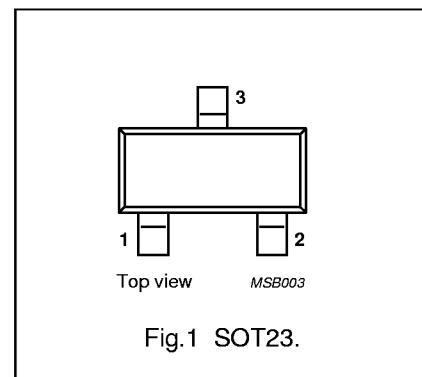


Fig.1 SOT23.

QUICK REFERENCE DATA

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V_{CBO}	collector-base voltage	open emitter	–	–	20	V
V_{CEO}	collector-emitter voltage	open base	–	–	15	V
I_C	DC collector current		–	–	100	mA
P_{tot}	total power dissipation	up to $T_s = 70^\circ\text{C}$; note 1	–	–	500	mW
h_{FE}	DC current gain	$I_C = 50 \text{ mA}; V_{CE} = 9 \text{ V}; T_{amb} = 25^\circ\text{C}$	25	80	–	
f_T	transition frequency	$I_C = 50 \text{ mA}; V_{CE} = 9 \text{ V}; f = 500 \text{ MHz}; T_{amb} = 25^\circ\text{C}$	–	5	–	GHz
G_{UM}	maximum unilateral power gain	$I_C = 30 \text{ mA}; V_{CE} = 6 \text{ V}; f = 800 \text{ MHz}; T_{amb} = 25^\circ\text{C}$	–	11.5	–	dB
V_o	output voltage	$I_C = 50 \text{ mA}; V_{CE} = 9 \text{ V}; R_L = 75 \Omega; T_{amb} = 25^\circ\text{C}; d_{im} = -60 \text{ dB}; f_{(p+q-r)} = 793.25 \text{ MHz}$	–	350	–	mV

LIMITING VALUES

In accordance with the Absolute Maximum System (IEC 134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V_{CBO}	collector-base voltage	open emitter	–	20	V
V_{CEO}	collector-emitter voltage	open base	–	15	V
V_{EBO}	emitter-base voltage	open collector	–	3	V
I_C	DC collector current		–	100	mA
P_{tot}	total power dissipation	up to $T_s = 70^\circ\text{C}$; note 1	–	500	mW
T_{stg}	storage temperature		-65	150	°C
T_j	junction temperature		–	175	°C

Note

1. T_s is the temperature at the soldering point of the collector tab.

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THERMAL RESISTANCE

SYMBOL	PARAMETER	CONDITIONS	THERMAL RESISTANCE
$R_{th\ j-s}$	thermal resistance from junction to soldering point	up to $T_s = 70^\circ\text{C}$; note 1	210 K/W

Note

1. T_s is the temperature at the soldering point of the collector tab.

CHARACTERISTICS

$T_j = 25^\circ\text{C}$ unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
I_{CBO}	collector cut-off current	$I_E = 0$; $V_{CB} = 10\text{ V}$	—	—	100	nA
h_{FE}	DC current gain	$I_C = 50\text{ mA}$; $V_{CE} = 9\text{ V}$	25	80	—	
f_T	transition frequency	$I_C = 50\text{ mA}$; $V_{CE} = 9\text{ V}$; $f = 500\text{ MHz}$; $T_{amb} = 25^\circ\text{C}$	—	5	—	GHz
C_c	collector capacitance	$I_E = i_e = 0$; $V_{CB} = 10\text{ V}$; $f = 1\text{ MHz}$	—	1.5	—	pF
C_e	emitter capacitance	$I_C = i_c = 0$; $V_{EB} = 0.5\text{ V}$; $f = 1\text{ MHz}$	—	4.5	—	pF
C_{re}	feedback capacitance	$I_C = 0$; $V_{CE} = 10\text{ V}$; $f = 1\text{ MHz}$	—	1.2	—	pF
G_{UM}	maximum unilateral power gain (note 1)	$I_C = 30\text{ mA}$; $V_{CE} = 6\text{ V}$; $f = 800\text{ MHz}$; $T_{amb} = 25^\circ\text{C}$	—	11.5	—	dB
F	noise figure	$I_C = 30\text{ mA}$; $V_{CE} = 6\text{ V}$; $f = 800\text{ MHz}$; $T_{amb} = 25^\circ\text{C}$	—	3.5	—	dB
d_2	second order intermodulation distortion	note 2	—	-50	—	dB
V_o	output voltage	note 3	—	350	—	mV

Notes

1. G_{UM} is the maximum unilateral power gain, assuming S_{12} is zero and

$$G_{UM} = 10 \log \left(\frac{|S_{21}|^2}{\left(1 - |S_{11}|^2 \right) \left(1 - |S_{22}|^2 \right)} \right) \text{ dB.}$$

2. $I_C = 30\text{ mA}$; $V_{CE} = 6\text{ V}$; $R_L = 75\text{ }\Omega$; $T_{amb} = 25^\circ\text{C}$;

$$f_{(p+q)} = 810\text{ MHz}; V_o = 100\text{ mV}.$$

3. $d_{im} = -60\text{ dB}$ (DIN 45004B); $I_C = 50\text{ mA}$; $V_{CE} = 9\text{ V}$; $R_L = 75\text{ }\Omega$; $T_{amb} = 25^\circ\text{C}$; $f_{(p+q-r)} = 793.25\text{ MHz}$.

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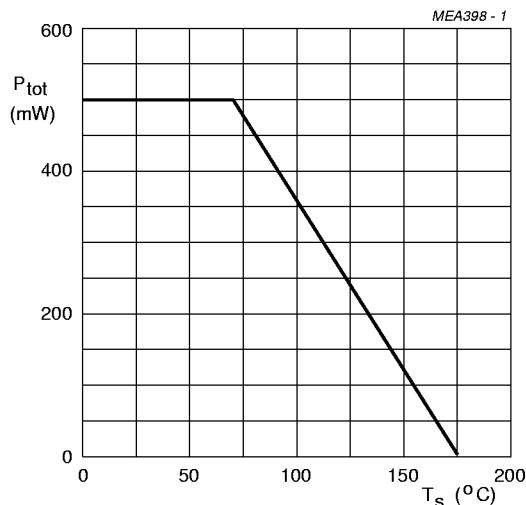


Fig.2 Power derating curve.

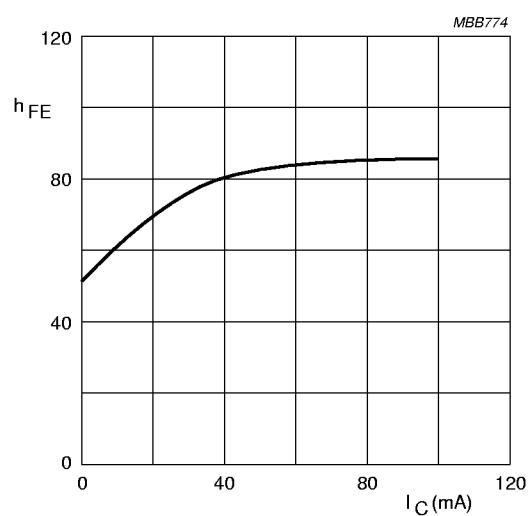
 $V_{CE} = 9$ V; $T_{amb} = 25$ $^{\circ}$ C.

Fig.3 DC current gain as a function of collector current.

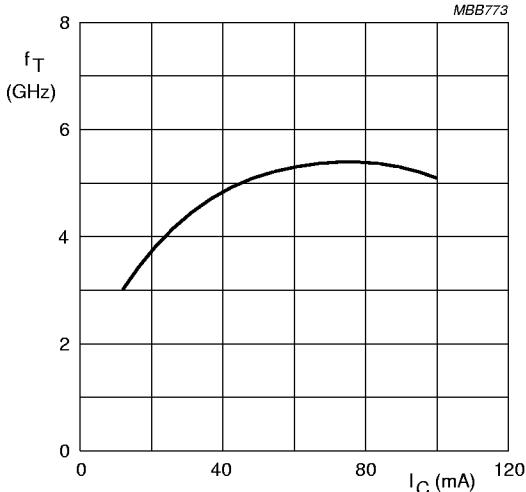
 $V_{CE} = 9$ V; $f = 500$ MHz; $T_j = 25$ $^{\circ}$ C.

Fig.4 Transition frequency as a function of collector current.

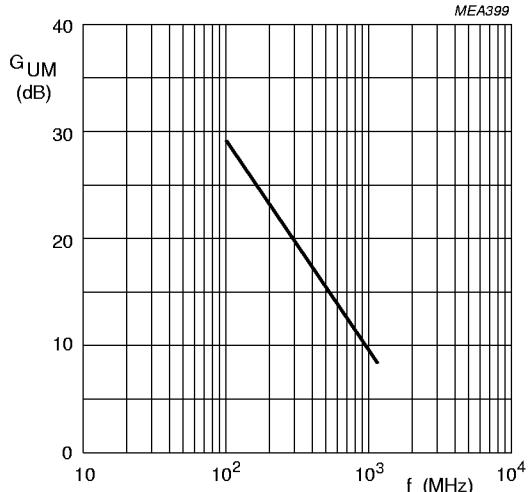
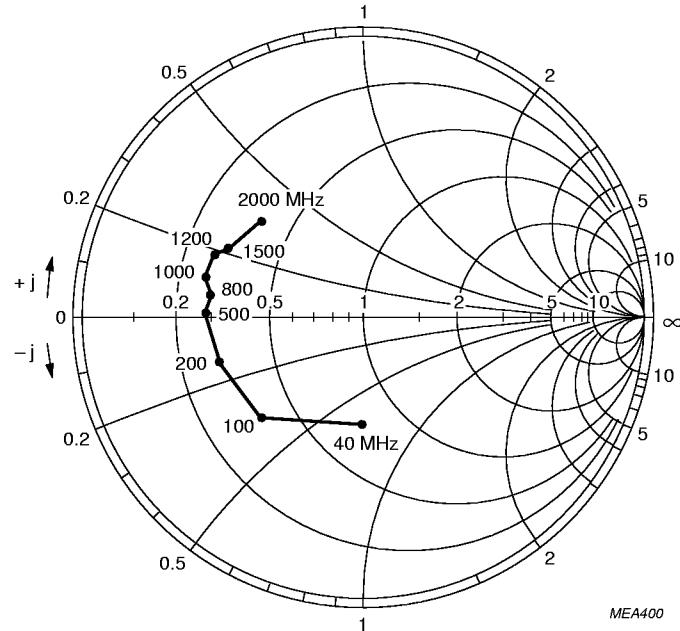
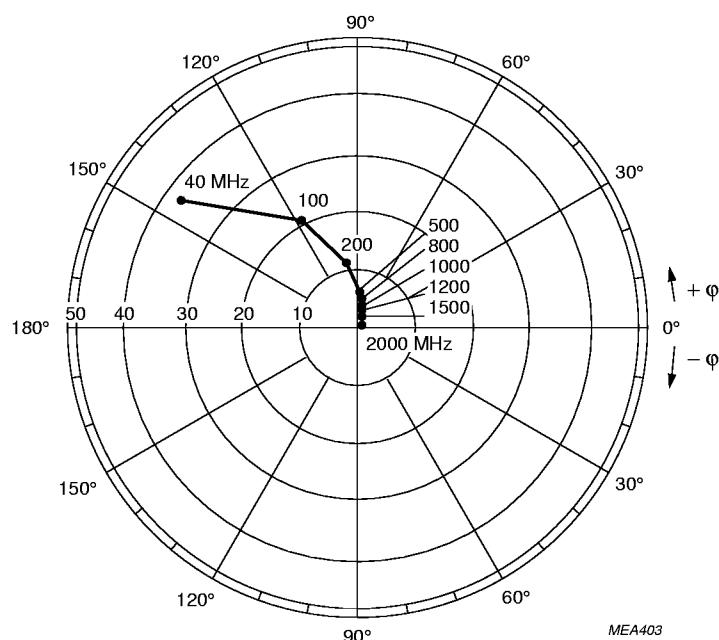
 $I_C = 30$ mA; $V_{CE} = 6$ V; $T_{amb} = 25$ $^{\circ}$ C.

Fig.5 Maximum unilateral power gain as a function of frequency.

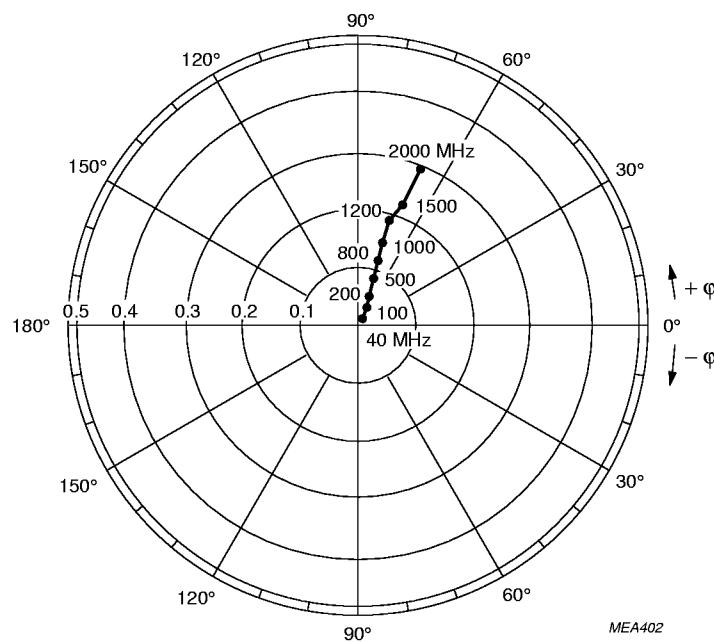
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 $I_C = 30 \text{ mA}; V_{CE} = 6 \text{ V}; T_{amb} = 25^\circ\text{C}.$ $Z_0 = 50 \Omega.$ Fig.6 Common emitter input reflection coefficient (S_{11}). $I_C = 30 \text{ mA}; V_{CE} = 6 \text{ V}; T_{amb} = 25^\circ\text{C}.$ Fig.7 Common emitter forward transmission coefficient (S_{21}).

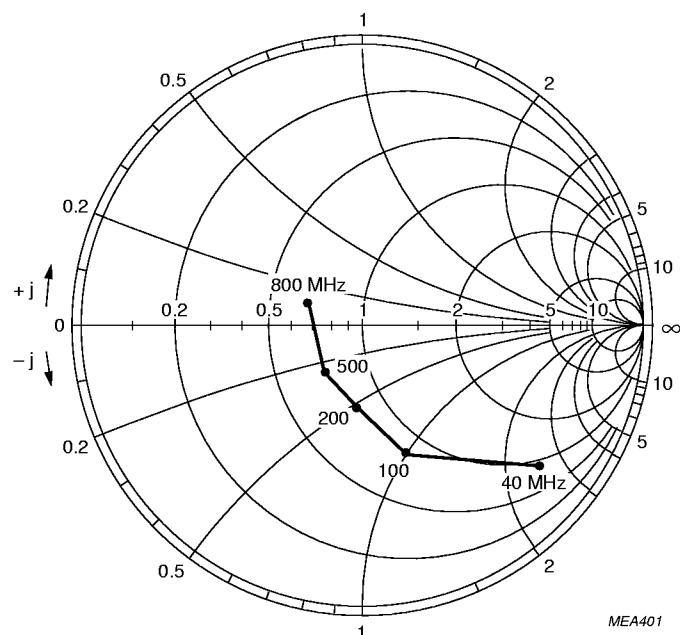
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$I_C = 30 \text{ mA}; V_{CE} = 6 \text{ V}; T_{amb} = 25^\circ \text{C}.$

Fig.8 Common emitter reverse transmission coefficient (S_{12}).



$I_C = 30 \text{ mA}; V_{CE} = 6 \text{ V}; T_{amb} = 25^\circ \text{C}.$
 $Z_0 = 50 \Omega.$

Fig.9 Common emitter output reflection coefficient (S_{22}).

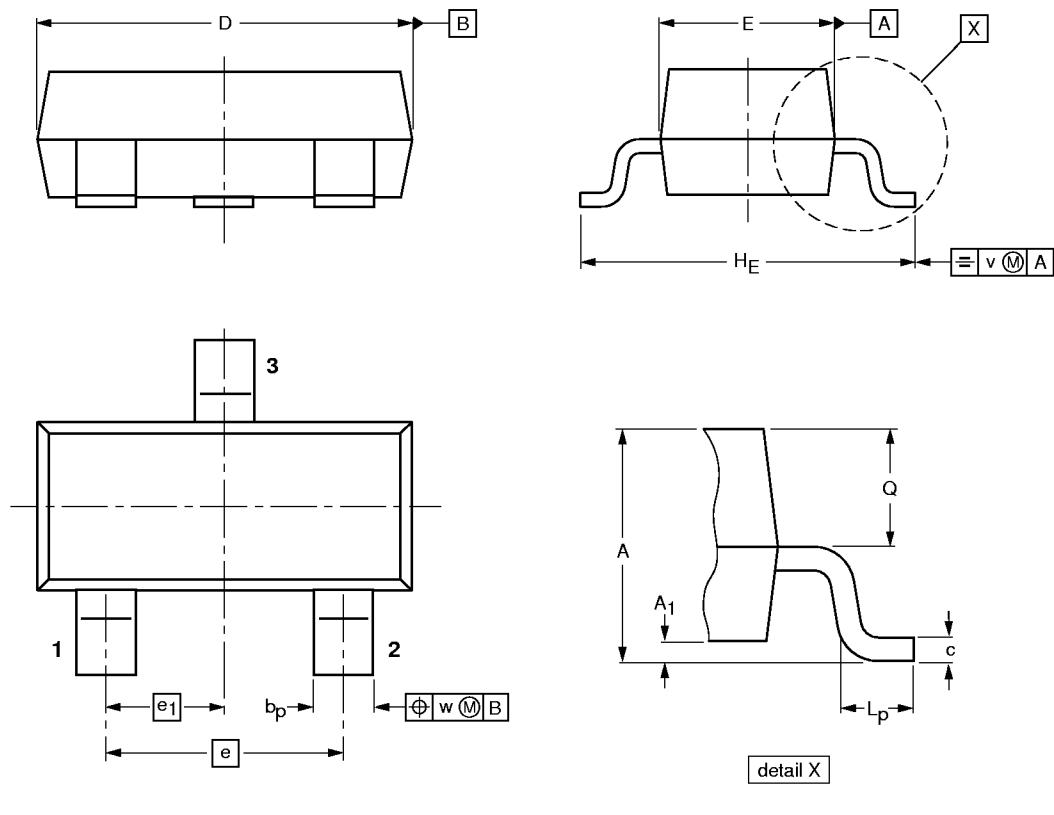
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PACKAGE OUTLINE

Plastic surface mounted package; 3 leads

SOT23



0 1 2 mm
scale

DIMENSIONS (mm are the original dimensions)

UNIT	A	A ₁ max.	b _p	c	D	E	e	e ₁	H _E	L _p	Q	v	w
mm	1.1 0.9	0.1	0.48 0.38	0.15 0.09	3.0 2.8	1.4 1.2	1.9	0.95	2.5 2.1	0.45 0.15	0.55 0.45	0.2	0.1

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT23						97-02-28